AN48840B, AN48841B

Low current consumption, high sensitivity CMOS Hall IC Alternating magnetic field operation

(For low-speed rotation detection)

Overview

The AN48840B/AN48841B Series is a Hall ICs (a magnetic sensor) which has 2 times or more sensitivity and a low current consumption of about one fiftieth compared with our conventional one.

In this Hall IC, a Hall element, a offset cancel circuit, an amplifier circuit, a sample and hold circuit, a Schmidt circuit, and output stage FET are integrated on a single chip housed in a small package by IC technique.

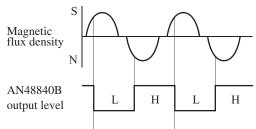
■ Features

- High sensitivity (AN48840B: 6 mT max., AN48841B: 8 mT max.)
 due to offset cancel circuit and a new sample and hold circuit
- Small current by using intermittent action
 (Average supply current: 56 μA typ., Sampling period: 670 μs typ.)
- Small package (SMD)
- CMOS inverter output (logic output form)

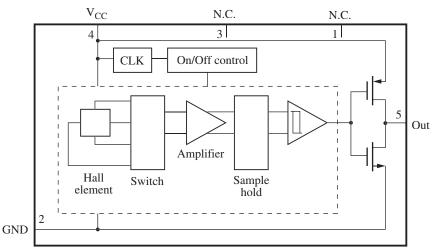
■ Applications

• Functional operation key, Mouse, Appliances for low-speed rotation detection

Unit : mm 0.22**0.10 0.22**0.10 0.22**0.10 0.20**0.13 Unit : mm



■ Block Diagram



■ Pin Descriptions

Pin No.	Symbol	Description	Pin No.	Symbol	Description
1	N.C.	_	4	V _{CC}	Power supply
2	GND	Ground	5	Out	Output
3	N.C.	_			

■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage	V _{CC}	5	V
Output voltage	V _{OUT}	5	V
Supply current	I _{CC}	5	mA
Output current	I _{OUT}	15	mA
Power dissipation *1,*2	P_{D}	60	mW
Operating ambient temperature *1	T _{opr}	-25 to +75	°C
Storage temperature *1	T _{stg}	-55 to +125	°C

Note) *1: Except for the power dissipation, operating ambient temperature and storage temperature, all ratings are for T_a = 25°C.

■ Recommended Operating Range

Parameter		Symbol	Range	Unit
Supply voltage	AN48840B	V _{CC}	2.5 to 3.5	V
	AN48841B		2.5 to 5.25	

■ Electrical Characteristics $T_a = 25$ °C ± 2 °C

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Operating magnetic flux density 1 *1	AN48840B	B_{HL}	$V_{CC} = 3 \text{ V}, V_{CC} = 2.5 \text{ V}$	0.5	_	6	mT
	AN48841B			0.5	_	8	mT
Operating magnetic flux density 2 *2	AN48840B	B_{LH}	$V_{CC} = 3 \text{ V}, V_{CC} = 2.5 \text{ V}$	-6	_	-0.5	mT
	AN48841B			-8	_	- 0.5	mT
Output voltage 1		V _{OL1}	$V_{CC} = 3 \text{ V}, I_{O} = 2 \text{ mA}, B = 6.0 \text{ mT}$	_	0.1	0.3	V
Output voltage 1		V _{OL2}	$V_{CC} = 2.5 \text{ V}, I_O = 2 \text{ mA}, B = 6.0 \text{ mT}$	_	0.1	0.3	V
Output voltage 2		V _{OH1}	$V_{CC} = 3 \text{ V}, I_{O} = -2 \text{ mA}, B = -6.0 \text{ mT}$	2.7	2.9	_	V
Output voltage 2		V _{OH2}	$V_{CC} = 2.5 \text{ V}, I_{O} = -2 \text{ mA}, B = -6.0 \text{ mT}$	2.7	2.9	_	V
Supply current 1 *3		I _{CC_{AVE}}	$V_{CC} = 3 \text{ V}$	_	56.0	85.0	μА
Supply current 2 *3		I _{CC2AVE}	$V_{\rm CC} = 2.5 \text{ V}$	_	48.0	72.0	μА
Intermittent action time		Tsam	$V_{CC} = 3 \text{ V}$	490	670	850	μS
Intermittent action time 2		Tsam2	$V_{\rm CC} = 2.5 \text{ V}$	513	710	890	μS

Note) *1: Symbol B_{H-LS} , B_{H-LN} stands for the operating magnetic flux density where its output level varies from high to low.

• Design reference data

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Hysteresis width	BW	$V_{CC} = 3 V$	_	7	_	mT
Supply current 3	I _{CCON}	$V_{CC} = 3 V$	_	1.4	2.1	mA
Supply current 4	I _{CCOFF}	$V_{CC} = 3 V$	_	2.5	_	μA
Supply current 5	I _{CC2ON}	$V_{\rm CC} = 2.5 \text{ V}$	_	1.12	1.68	mA
Supply current 6	I _{CC2OFF}	$V_{CC} = 2.5 \text{ V}$	_	2.2	_	μΑ
Operating time	t _{ON}	$T_a = -25$ °C to 75°C, $V_{CC} = 3$ V	10	26	42	μS
Stop time	t _{OFF}	$T_a = -25$ °C to 75°C, $V_{CC} = 3 \text{ V}$	258	644	1 030	μS
Operating time 2	t _{2ON}	$T_a = -25$ °C to 75°C, $V_{CC} = 2.5$ V	11	27	43	μS
Stop time 2	t _{2OFF}	$T_a = -25$ °C to 75°C, $V_{CC} = 2.5$ V	270	674	1 078	μS

Note) It will operate normally in approximately 0.67 ms after power on.

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 $^{*2:}T_a = 75$ °C. For the independent IC without a heat sink. Please use within the range of power dissipation, refering to $P_D - T_a$ curve.

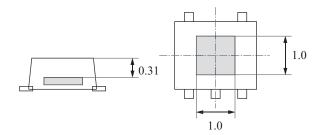
 $^{*2.} Symbol \ B_{L\text{-HS}} \ , B_{L\text{-HN}} \ stands \ for \ the \ operating \ magnetic \ flux \ density \ where \ its \ output \ level \ varies \ from \ low \ to \ high.$

 $^{*3:} I_{\text{CC}_{\text{AVE}}} = \{I_{\text{CC}_{\text{ON}}} \times t_{\text{ON}} + I_{\text{CC}_{\text{OFF}}} \times t_{\text{OFF}}\} / \{t_{\text{ON}} + t_{\text{OFF}}\}$

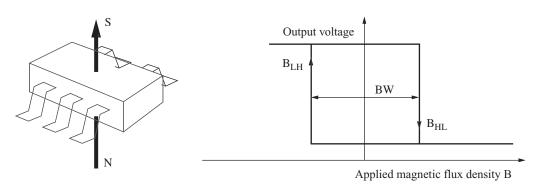
■ Technical Data

• Position of a Hall element (unit in mm)

Distance from a package surface to sensor part: 0.31 mm (reference value) A Hall element is placed on the shaded part in the figure.



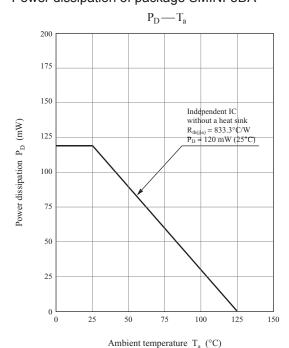
• Magneto-electro conversion characteristics



Direction of applied magnetic field

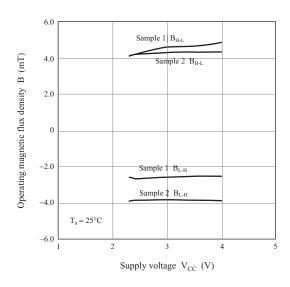
Operating magnetic flux density

• Power dissipation of package SMINI-5DA



AN48840B Main characterisitcs

Operating magnetic flux density — Supply voltage

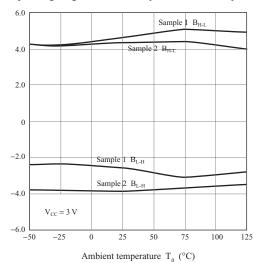


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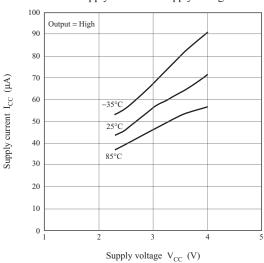
■ Technical Data (continued)

• AN48840B Main characterisitcs (continued)

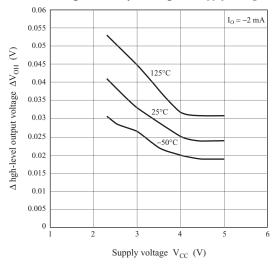
Operating magnetic flux density — Ambient temperature



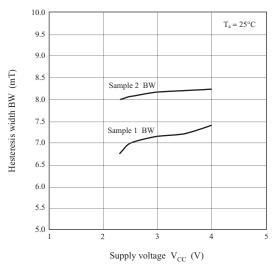
Supply current — Supply voltage



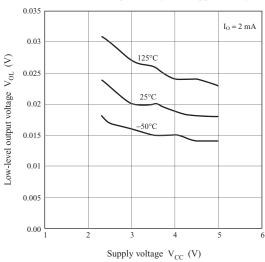
 Δ high-level output voltage — Supply voltage



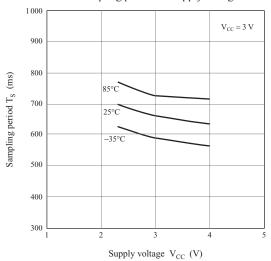
Hysteresis width — Supply voltage



Low-level output voltage — Supply voltage



Sampling period — Supply voltage



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